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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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HAT2279H Silicon N Channel Power MOS FET

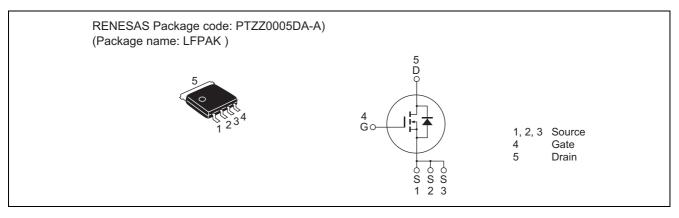
Power Switching

REJ03G1464-0200 Rev.2.00 Jul 05, 2006

Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance
 - $R_{DS(on)} = 9.5 \text{ m}\Omega \text{ typ.}$ (at $V_{GS} = 10 \text{ V}$)
- Lead Free

Outline



Absolute Maximum Ratings

			(Ta = 25°C)
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	80	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	30	A
Drain peak current	Note1 I _{D(pulse)}	120	A
Body-drain diode reverse drain current	I _{DR}	30	A
Avalanche current	I _{AP} Note 2	25	A
Avalanche energy	E _{AR} Note 2	83	mJ
Channel dissipation	Pch Note3	25	W
Channel to Case Thermal Resistance	θch-C	5	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 µs, duty cycle \leq 1%

2. Value at Tch = 25° C, Rg $\geq 50 \Omega$

3. Tc = 25°C



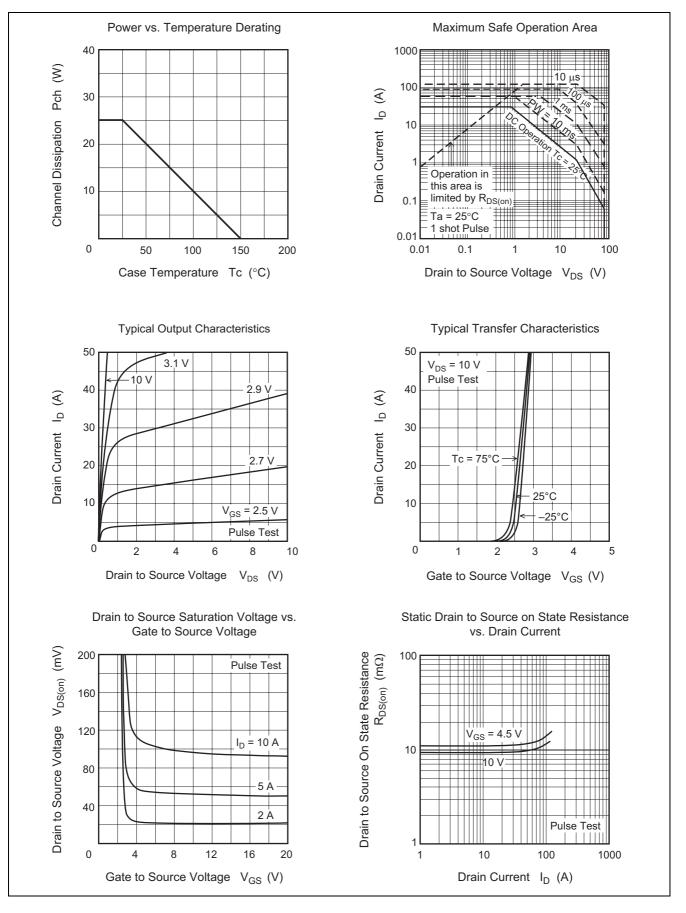
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
ltem	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	80	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}			±0.5	μΑ	$V_{GS} = \pm 20 V, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}			1	μΑ	$V_{DS} = 80 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	0.8		2.3	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}		9.5	12	mΩ	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R _{DS(on)}		11	15	mΩ	$I_D = 15 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	42	70	_	S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss		3520	_	pF	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0,$ f = 1 MHz
Output capacitance	Coss		410	_	pF	
Reverse transfer capacitance	Crss		160	_	pF	
Gate Resistance	Rg		0.5		Ω	
Total gate charge	Qg		60		nC	$V_{DD} = 25 \text{ V}, \text{ V}_{GS} = 10 \text{ V},$ $I_D = 30 \text{ A}$
Gate to source charge	Qgs		9.5		nC	
Gate to drain charge	Qgd		9.0		nC	
Turn-on delay time	t _{d(on)}		9.5		ns	V _{GS} = 10 V, I _D = 15 A,
Rise time	tr		14.5	_	ns	$V_{\text{DD}} \cong 30 \text{ V}, \text{ R}_{\text{L}} = 2 \Omega,$ Rg = 4.7 Ω
Turn-off delay time	t _{d(off)}		56		ns	
Fall time	t _f		9.5		ns	
Body-drain diode forward voltage	V _{DF}		0.83	1.08	V	$IF = 30 A, V_{GS} = 0^{Note4}$
Body-drain diode reverse recovery	t _{rr}	_	50	—	ns	IF = 30 A, V _{GS} = 0
time						di _F / dt = 100 A/ μs

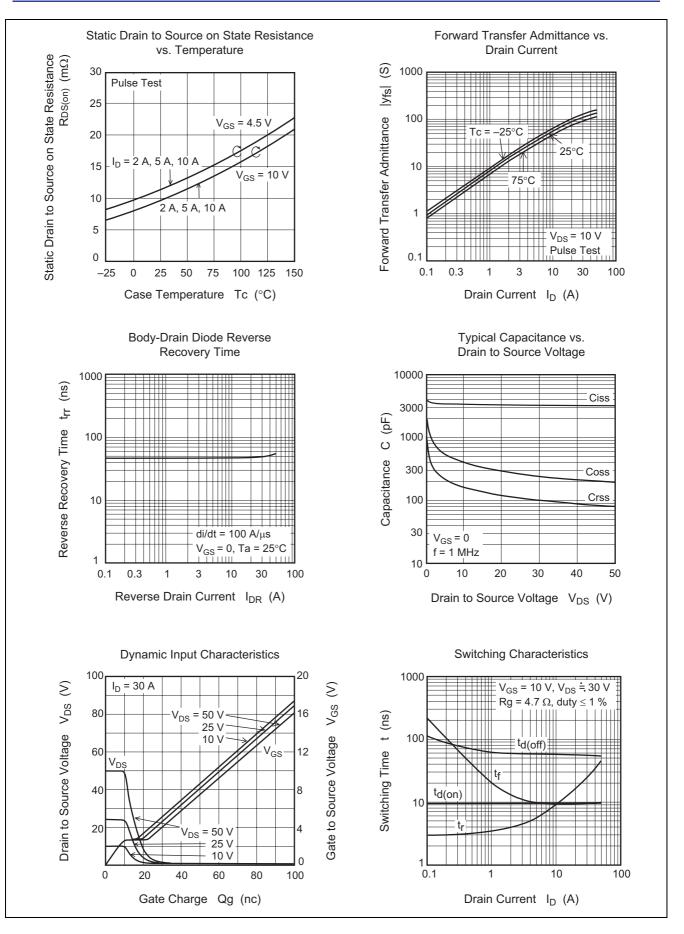
Notes: 4. Pulse test



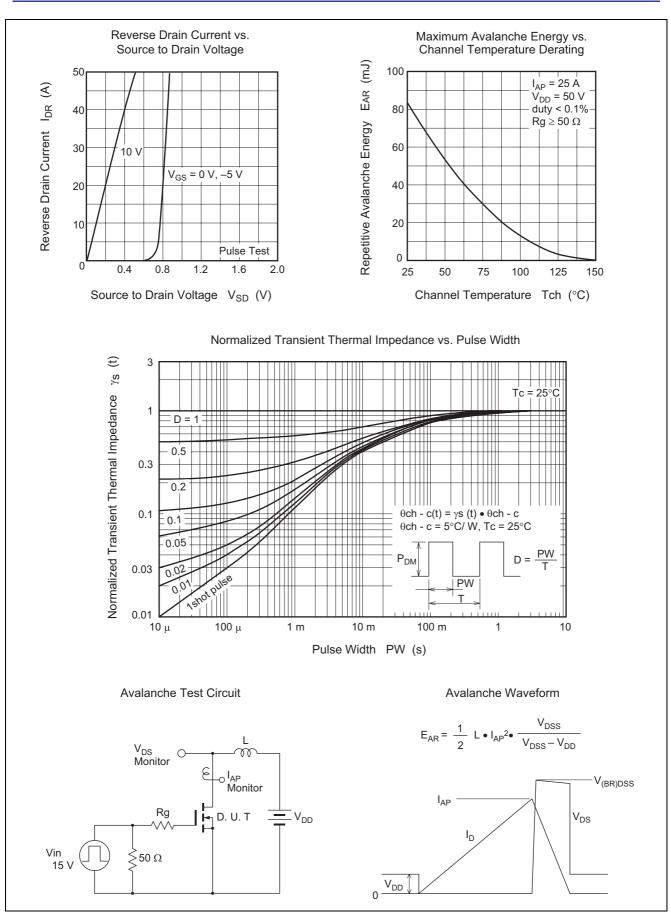
Main Characteristics



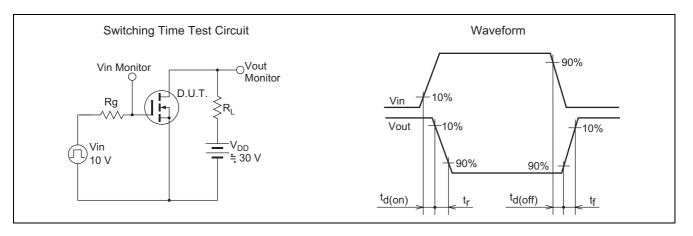






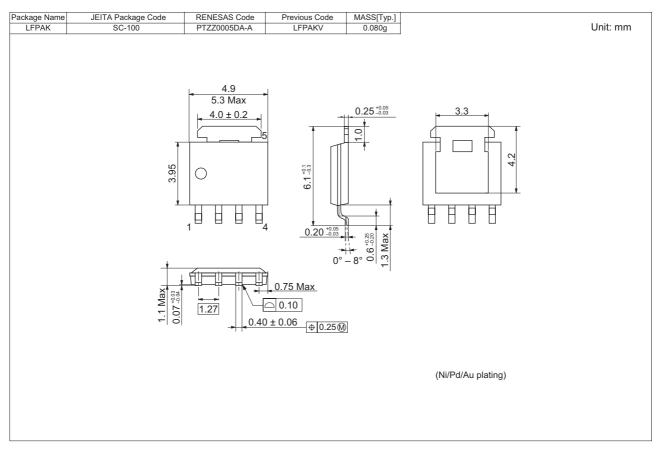








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container		
HAT2279H-EL-E	2500 pcs	Taping		
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